

GENERAL DESCRIPTION

The 74LVCN244 is an octal buffer/line driver with non-inverting 3-state bus outputs and accepts a wide supply voltage range of 1.2V to 3.6V. The device is organized as two 4-bit line drivers with separate output enable inputs ($1\overline{OE}$ and $2\overline{OE}$). When $n\overline{OE}$ is held low, data transmits from the nA_n inputs to the nY_n outputs. When $n\overline{OE}$ is held high, the outputs are in high-impedance state.

The input from 3.3V or 5V device makes this device to operate as a translator in a mixed 3.3V and 5V system environment. And in 3-state operation, outputs can tolerate up to 5V.

FEATURES

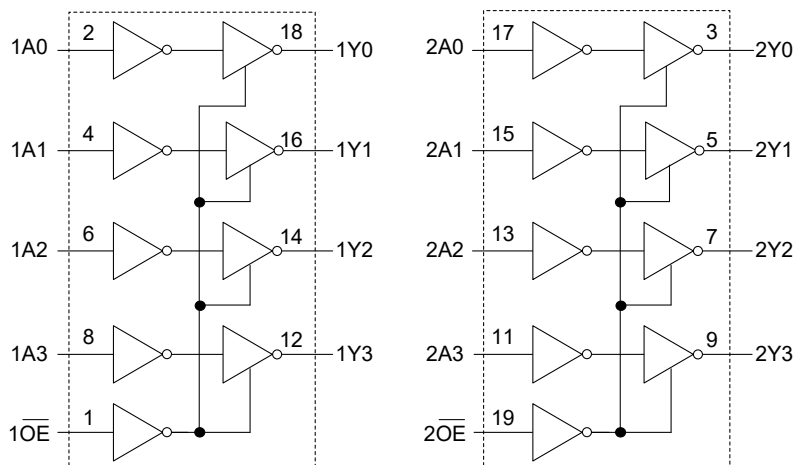
- **Wide Supply Voltage Range: 1.2V to 3.6V**
- **Input and Output Interface Capability to 5V System Environment**
- **+24mA/-24mA Output Current**
- **3-State Outputs Drive Bus Lines Directly**
- **I_{OFF} 3-State**
- **-40°C to +125°C Operating Temperature Range**
- **Available in Green SOIC-20, TSSOP-20 and SSOP-20 Packages**

FUNCTION TABLE

CONTROL INPUT	INPUT	OUTPUT
$n\overline{OE}$	nA_n	nY_n
L	L	L
L	H	H
H	X	Z

H = High Voltage Level
 L = Low Voltage Level
 Z = High-Impedance State
 X = Don't Care

LOGIC DIAGRAM



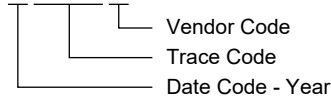
PACKAGE/ORDERING INFORMATION

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION
74LVCN244	SOIC-20	-40°C to +125°C	74LVCN244XS20G/TR	74LVCN244XS20 XXXXX	Tape and Reel, 1500
	TSSOP-20	-40°C to +125°C	74LVCN244XTS20G/TR	GKEXTS20 XXXXX	Tape and Reel, 4000
	SSOP-20	-40°C to +125°C	74LVCN244XSS20G/TR	74LVCN244 XSS20 XXXXX	Tape and Reel, 2000

MARKING INFORMATION

XXXXX = Date Code, Trace Code and Vendor Code.

XXXXX



Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

ABSOLUTE MAXIMUM RATINGS ⁽¹⁾

Supply Voltage, V_{CC}	-0.5V to 6.5V
Input Voltage, V_I ⁽²⁾	-0.5V to 6.5V
Output Voltage, V_O ⁽²⁾	
Output in High-State or Low-State	-0.5V to ($V_{CC} + 0.5V$)
Output in 3-State.....	-0.5V to 6.5V
Input Clamping Current, I_{IK} ($V_I < 0V$).....	-50mA
Output Clamping Current, I_{OK} ($V_O > V_{CC}$ or $V_O < 0V$)...±	50mA
Output Current, I_O	
Output in High-State	-50mA
Output in Low-State	50mA
Supply Current, I_{CC}	100mA
Ground Current, I_{GND}	-100mA
Junction Temperature ⁽³⁾	+150°C
Storage Temperature Range	-65°C to +150°C
Lead Temperature (Soldering, 10s).....	+260°C
ESD Susceptibility	
HBM.....	4000V
CDM	1000V

RECOMMENDED OPERATING CONDITIONS

Function Supply Voltage, V_{CC}	1.2V to 3.6V
Operating Supply Voltage, V_{CC}	1.65V to 3.6V
Input Voltage, V_I	0V to 5.5V
High-Level Output Current, I_{OH}	-24mA
Low-Level Output Current, I_{OL}	24mA
Input Transition Rise and Fall Rate, $\Delta t/\Delta V$	
$V_{CC} = 1.2V$ to 2.7V	20ns/V (MAX)
$V_{CC} = 2.7V$ to 3.6V	10ns/V (MAX)
Operating Temperature Range	-40°C to +125°C

OVERSTRESS CAUTION

1. Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.
2. The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.
3. The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability.

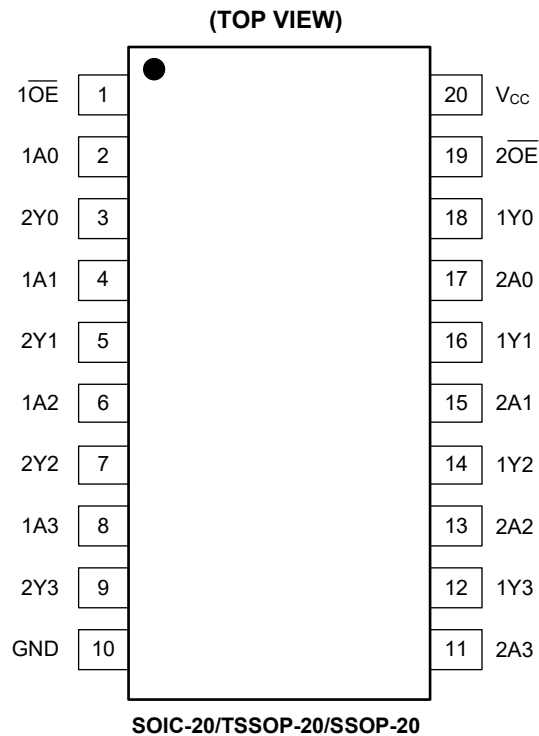
ESD SENSITIVITY CAUTION

This integrated circuit can be damaged if ESD protections are not considered carefully. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because even small parametric changes could cause the device not to meet the published specifications.

DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

PIN CONFIGURATIONS



PIN DESCRIPTION

NAME	PIN	FUNCTION
1OE, 2OE	1, 19	Output Enable Inputs (Active Low).
1A0, 1A1, 1A2, 1A3	2, 4, 6, 8	Data Inputs.
2Y0, 2Y1, 2Y2, 2Y3	3, 5, 7, 9	Data Outputs.
GND	10	Ground.
2A0, 2A1, 2A2, 2A3	17, 15, 13, 11	Data Inputs.
1Y0, 1Y1, 1Y2, 1Y3	18, 16, 14, 12	Data Outputs.
V _{CC}	20	Supply Voltage.

ELECTRICAL CHARACTERISTICS(Full = -40°C to +125°C, all typical values are measured at $V_{CC} = 3.3V$ and $T_A = +25^\circ C$, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	TEMP	MIN	TYP	MAX	UNITS	
High-Level Input Voltage	V_{IH}	$V_{CC} = 1.2V$	Full	1.08			V	
		$V_{CC} = 1.65V$ to $1.95V$	Full	$0.65 \times V_{CC}$				
		$V_{CC} = 2.3V$ to $2.7V$	Full	1.7				
		$V_{CC} = 2.7V$ to $3.6V$	Full	2				
Low-Level Input Voltage	V_{IL}	$V_{CC} = 1.2V$	Full			0.12	V	
		$V_{CC} = 1.65V$ to $1.95V$	Full			$0.35 \times V_{CC}$		
		$V_{CC} = 2.3V$ to $2.7V$	Full			0.7		
		$V_{CC} = 2.7V$ to $3.6V$	Full			0.8		
High-Level Output Voltage	V_{OH}	$V_I = V_{IH}$	$I_O = -100\mu A$, $V_{CC} = 1.65V$ to $3.6V$	Full	$V_{CC} - 0.05$		V	
			$I_O = -4mA$, $V_{CC} = 1.65V$	Full	1.45	1.54		
			$I_O = -8mA$, $V_{CC} = 2.3V$	Full	2.05	2.18		
			$I_O = -12mA$, $V_{CC} = 2.7V$	Full	2.38	2.55		
			$I_O = -18mA$, $V_{CC} = 3.0V$	Full	2.55	2.8		
			$I_O = -24mA$, $V_{CC} = 3.0V$	Full	2.4	2.73		
Low-Level Output Voltage	V_{OL}	$V_I = V_{IL}$	$I_O = 100\mu A$, $V_{CC} = 1.65V$ to $3.6V$	Full			0.05	V
			$I_O = 4mA$, $V_{CC} = 1.65V$	Full		0.07	0.18	
			$I_O = 8mA$, $V_{CC} = 2.3V$	Full		0.11	0.28	
			$I_O = 12mA$, $V_{CC} = 2.7V$	Full		0.16	0.35	
			$I_O = 24mA$, $V_{CC} = 3.0V$	Full		0.3	0.55	
Input Leakage Current	I_I	$V_I = 5.5V$ or GND, $V_{CC} = 3.6V$	Full		± 0.05	± 2	μA	
Off-State Output Current	I_{OZ}	$V_I = V_{IH}$ or V_{IL} , $V_O = 5.5V$ or GND, $V_{CC} = 3.6V$	Full		± 0.01	± 2	μA	
Power-Off Leakage Current	I_{OFF}	V_I or $V_O = 5.5V$, $V_{CC} = 0V$	Full		0.02	5	μA	
Supply Current	I_{CC}	$V_I = V_{CC}$ or GND, $I_O = 0A$, $V_{CC} = 3.6V$	Full		0.05	10	μA	
Additional Supply Current	ΔI_{CC}	Per input pin, $V_I = V_{CC} - 0.6V$, $I_O = 0A$, $V_{CC} = 2.7V$ to $3.6V$	Full		0.1	80	μA	
Input Capacitance	C_I		+25°C		5		pF	

DYNAMIC CHARACTERISTICS(For test circuit see Figure 1. Full = -40°C to +125°C, all typical values are measured T_A = +25°C, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	TEMP	MIN ⁽¹⁾	TYP	MAX ⁽¹⁾	UNITS	
Propagation Delay ⁽²⁾	t _{PD}	nAn to nYn, see Figure 2	V _{CC} = 1.2V	Full		22.0	ns	
			V _{CC} = 1.65V to 1.95V	Full	0.5	5.5		14.0
			V _{CC} = 2.3V to 2.7V	Full	0.5	3.5		8.0
			V _{CC} = 2.7V	Full	0.5	3.5		8.0
			V _{CC} = 3.0V to 3.6V	Full	0.5	3.5		7.0
Enable Time ⁽²⁾	t _{EN}	nOE to nYn, see Figure 3	V _{CC} = 1.2V	Full		19.0	ns	
			V _{CC} = 1.65V to 1.95V	Full	0.5	7.5		16.0
			V _{CC} = 2.3V to 2.7V	Full	0.5	4.5		9.0
			V _{CC} = 2.7V	Full	0.5	4.5		9.0
			V _{CC} = 3.0V to 3.6V	Full	0.5	4.0		8.0
Disable Time ⁽²⁾	t _{DIS}	nOE to nYn, see Figure 3	V _{CC} = 1.2V	Full		12.0	ns	
			V _{CC} = 1.65V to 1.95V	Full	0.5	5.0		11.0
			V _{CC} = 2.3V to 2.7V	Full	0.5	4.5		6.4
			V _{CC} = 2.7V	Full	0.5	4.5		8.0
			V _{CC} = 3.0V to 3.6V	Full	0.5	4.0		7.0
Power Dissipation Capacitance ⁽³⁾	C _{PD}	Per input, V _I = GND to V _{CC}	V _{CC} = 1.65V to 1.95V	+25°C		12.0	pF	
			V _{CC} = 2.3V to 2.7V	+25°C		13.0		
			V _{CC} = 3.0V to 3.6V	+25°C		14.0		

NOTES:

- Specified by design and characterization; not production tested.
- t_{PD} is the same as t_{PLH} and t_{PHL}. t_{EN} is the same as t_{PZL} and t_{PZH}. t_{DIS} is the same as t_{PLZ} and t_{PHZ}.
- C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$$

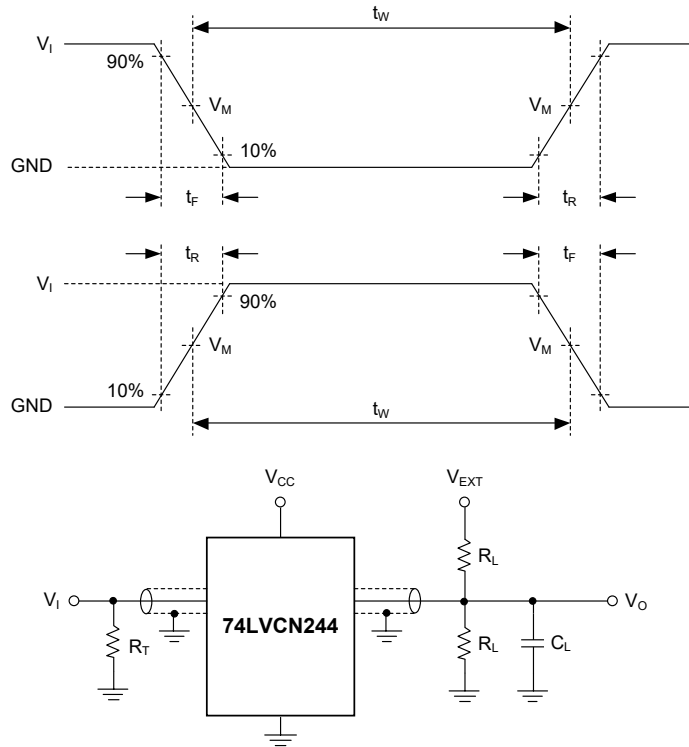
where:

f_i = Input frequency in MHz.f_o = Output frequency in MHz.C_L = Output load capacitance in pF.V_{CC} = Supply voltage in Volts.

N = Number of inputs switching.

Σ(C_L × V_{CC}² × f_o) = Sum of the outputs.

TEST CIRCUIT



Test conditions are given in Table 1.

Definitions for test circuit:

R_L : Load resistance.

C_L : Load capacitance (includes jig and probe).

R_T : Termination resistance (equals to output impedance Z_o of the pulse generator).

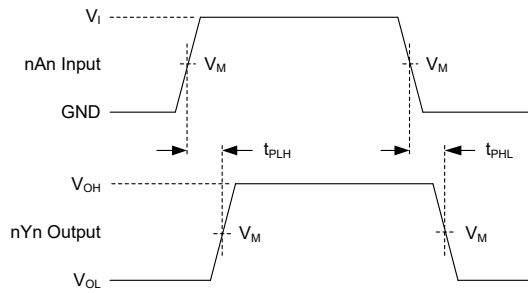
V_{EXT} : External voltage used to measure switching time.

Figure 1. Test Circuit for Measuring Switching Times

Table 1. Test Conditions

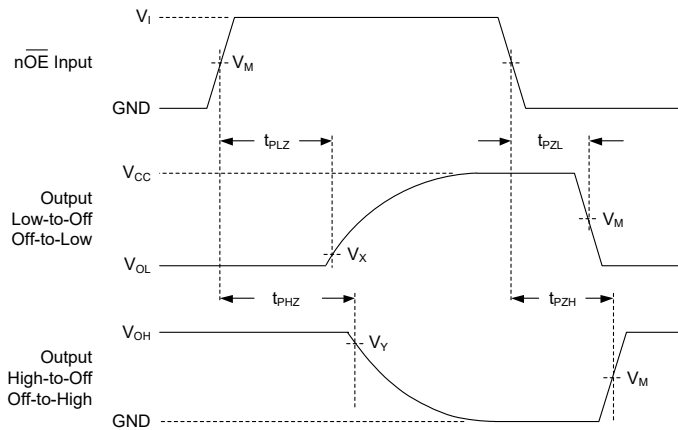
SUPPLY VOLTAGE	INPUT		LOAD		V_{EXT}			
	V_{CC}	V_I	t_R, t_F	C_L	R_L	t_{PLH}, t_{PHL}	t_{PLZ}, t_{PZL}	t_{PHZ}, t_{PZH}
1.2V	V_{CC}	V_{CC}	$\leq 2ns$	30pF	1k Ω	Open	$2 \times V_{CC}$	GND
1.65V to 1.95V	V_{CC}	V_{CC}	$\leq 2ns$	30pF	1k Ω	Open	$2 \times V_{CC}$	GND
2.3V to 2.7V	V_{CC}	V_{CC}	$\leq 2ns$	30pF	500 Ω	Open	$2 \times V_{CC}$	GND
2.7V	2.7V	2.7V	$\leq 2.5ns$	50pF	500 Ω	Open	$2 \times V_{CC}$	GND
3.0V to 3.6V	2.7V	2.7V	$\leq 2.5ns$	50pF	500 Ω	Open	$2 \times V_{CC}$	GND

WAVEFORMS



Test conditions are given in Table 1.
Measurement points are given in Table 2.
Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Figure 2. Input (nAn) to Output (nYn) Propagation Delays



Test conditions are given in Table 1.
Measurement points are given in Table 2.
Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Figure 3. Enable and Disable Times

Table 2. Measurement Points

SUPPLY VOLTAGE	INPUT		OUTPUT			
	V_{CC}	V_I	$V_M^{(1)}$	V_M	V_X	V_Y
1.2V	V_{CC}	V_{CC}	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{OL} + 0.15V$	$V_{OH} - 0.15V$
1.65V to 1.95V	V_{CC}	V_{CC}	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{OL} + 0.15V$	$V_{OH} - 0.15V$
2.3V to 2.7V	V_{CC}	V_{CC}	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{OL} + 0.15V$	$V_{OH} - 0.15V$
2.7V	2.7V	2.7V	1.5V	1.5V	$V_{OL} + 0.3V$	$V_{OH} - 0.3V$
3.0V to 3.6V	2.7V	2.7V	1.5V	1.5V	$V_{OL} + 0.3V$	$V_{OH} - 0.3V$

NOTE:

1. The measurement points should be V_{IH} or V_{IL} when the input rising or falling time exceeds 2.5ns.

REVISION HISTORY

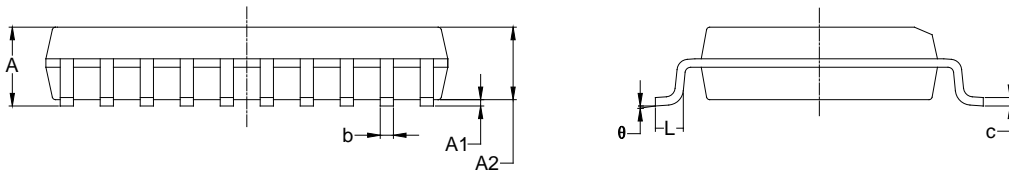
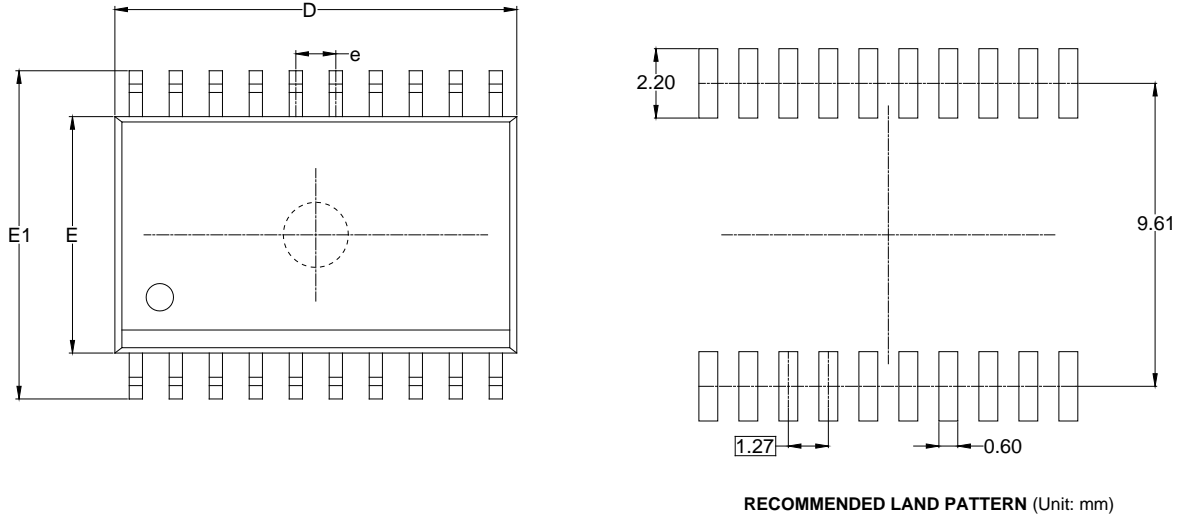
NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

MAY 2022 – REV.A to REV.A.1	Page
Added TSSOP-20 and SSOP-20 packages	All
Updated Dynamic Characteristics section	5

Changes from Original (MARCH 2021) to REV.A	Page
Changed from product preview to production data.....	All

PACKAGE OUTLINE DIMENSIONS

SOIC-20

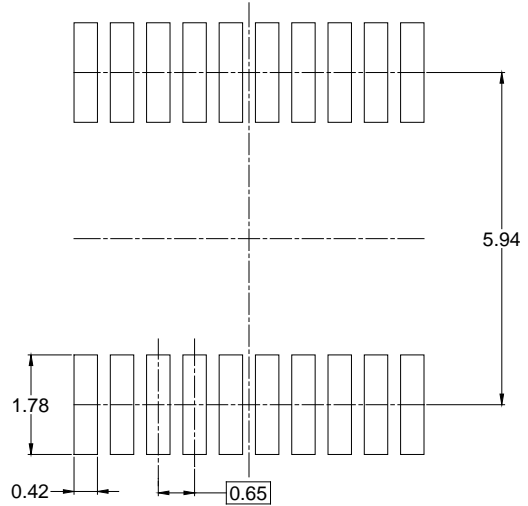
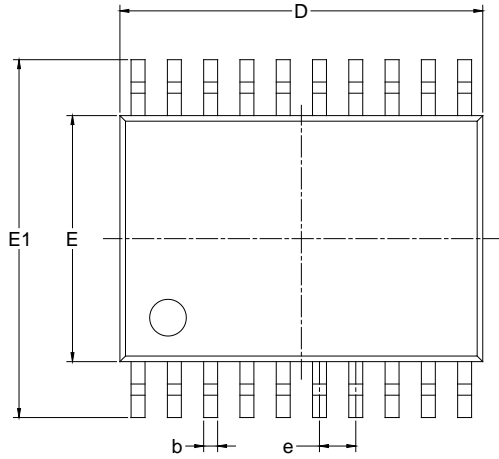


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	2.350	2.650	0.093	0.104
A1	0.100	0.300	0.004	0.012
A2	2.100	2.500	0.083	0.098
b	0.330	0.510	0.013	0.020
c	0.204	0.330	0.008	0.013
D	12.520	13.000	0.493	0.512
E	7.400	7.600	0.291	0.299
E1	10.210	10.610	0.402	0.418
e	1.27 BSC		0.050 BSC	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

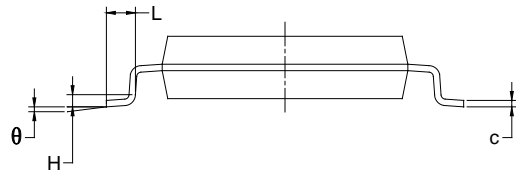
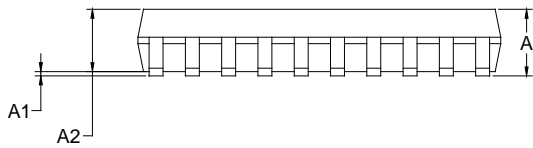
NOTES:
 1. Body dimensions do not include mode flash or protrusion.
 2. This drawing is subject to change without notice.

PACKAGE OUTLINE DIMENSIONS

TSSOP-20



RECOMMENDED LAND PATTERN (Unit: mm)



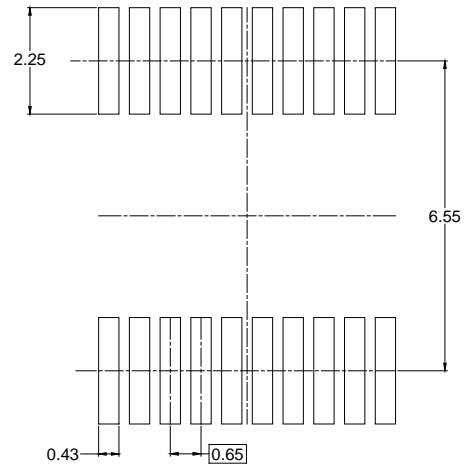
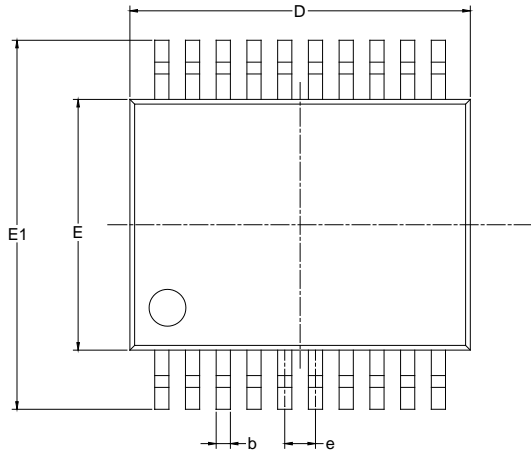
Symbol	Dimensions In Millimeters		
	MIN	MOD	MAX
A		-	1.200
A1	0.050	-	0.150
A2	0.800	-	1.050
b	0.190	-	0.300
c	0.090	-	0.200
D	6.400	-	6.600
E	4.300	-	4.500
E1	6.250	-	6.550
e	0.650 BSC		
L	0.450	-	0.750
H	0.250 TYP		
θ	0°	-	8°

NOTES:

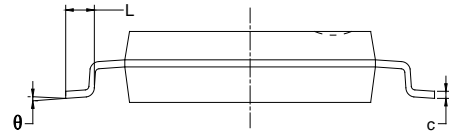
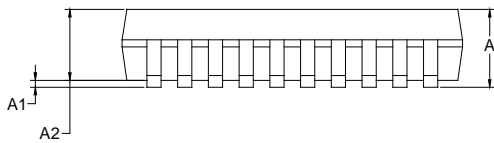
1. Body dimensions do not include mode flash or protrusion.
2. This drawing is subject to change without notice.

PACKAGE OUTLINE DIMENSIONS

SSOP-20



RECOMMENDED LAND PATTERN (Unit: mm)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A		1.730		0.068
A1	0.050	0.230	0.002	0.009
A2	1.400	1.600	0.055	0.063
b	0.220	0.380	0.009	0.015
c	0.090	0.250	0.004	0.010
D	7.000	7.400	0.276	0.291
E	5.100	5.500	0.201	0.217
E1	7.600	8.000	0.299	0.315
e	0.65 BSC		0.026 BSC	
L	0.550	0.950	0.022	0.037
θ	0°	8°	0°	8°

NOTES:

1. Body dimensions do not include mode flash or protrusion.
2. This drawing is subject to change without notice.

PACKAGE INFORMATION

TAPE AND REEL INFORMATION

REEL DIMENSIONS



TAPE DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
SOIC-20	13"	24.4	10.90	13.30	3.00	4.0	12.0	2.0	24.0	Q1
TSSOP-20	13"	16.4	6.80	6.90	1.50	4.0	8.0	2.0	16.0	Q1
SSOP-20	13"	16.4	8.40	7.75	2.50	4.0	12.0	2.0	16.0	Q1

DD0001

PACKAGE INFORMATION

CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
13"	386	280	370	5

DD0002